

CHIP-ON-TOP SMD TYPE LED



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Model No.: WS-L5256-CW-K1-1

Description: 5.4x5.0x1.6mm Top SMD Type 1-chip 0.2-Watt Power White LED







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Features and Benefits

- Ideal for LED lighting application to avoid multi-shadows
- Higher heat conductivity for better thermal management
- Provide variable and innovative array LED layout designs and combinations
- Reduce the initial development cost and time
- High lumen-performance per dollar cost
- Lead free reflow solder compatible with RoHS compliant

Applications

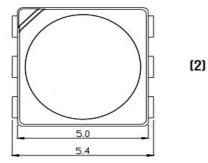
- Solid State Lighting
- Indoor/Outdoor/Decoration
- Signal Light Engine
- Commercial Display
- Industrial Light Engine

Dimensions and Materials

- Dimensions: 5.4 mm x 5.0 mm x 1.6 mm
- Packages: Top SMD
- Capsulated Resin: Silicone Resin with Silicate Phosphor
- Electrodes: Ag Plating
- Chips: ONE-chip packed in cavity

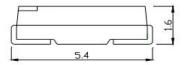
Unit : mm, Tolerance : ±0.1mm

(1)

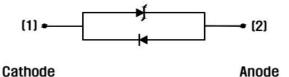


[Top view]

[Bottom view]



[Side view]



[Circuit diagram]

Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.1 mm unless otherwise noted.



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Electrical/Optical Characteristics (Thermal Pad Temperature @25°C)

Item		Symbol	Test Conditions	Unit	Min.	Тур.	Max.
Forward Voltage		Vf	If=60mA	V	2.8	3.2	3.4
Reverse Current		Ir	Vr-5V	μΑ			5
Viewing Angle	Viewing Angle			deg		120	
Color Rendering Index(*1)		CRI	If=60 mA		70	80	90
Junction/Solder 1 chips on (*2)		Rθj-с	If=60 mA	°C/W			4
	Rank H2	Iv	If=60 mA	mcd	4800		5400
Luminous Intensity (*3)	Rank J1				5400		6000
	Rank J2				6000		6600
	Rank E2	Фу	If=60 mA	lm	16		18
Luminous Flux(*4)	Rank F1				18		20
	Rank F2				20		22

- 1. Measurement tolerance of the Color Rendering Index: ± 2
- 2. Rth test condition: Mounted on PC Board FR 4(pad size≥16mm2)
- 3. Measurement tolerance of the luminous intensity: $\pm 10\%$. This value for reference only.
- 4. Measurement tolerance of the luminous flux: $\pm 10\%$.

Absolute Maximum Ratings (Thermal Pad Temperature @25°C)

Item	Symbol	Absolute Maximum Rating	Unit
D.C Forward Current	If	60	mA
Pulse Forward Current (*1)	Ifp	80	mA
Reverse Voltage	Vr	5	V
Power Dissipation	Pd	0.2	W
Operating Temperature	Topr	-25~+85	$^{\circ}$
Storage Temperature	Tstg	-40~+100	$^{\circ}$
Soldering Temperature (Reflow) (*2)	Tsld	max.240 <30 sec	$^{\circ}$ C

- 1. If p conditions: 1/10 Duty Cycle & 0.1ms for pulse width.
- 2. Reflow method: 1.2mm FR4 from body for 5 seconds not exceeding the recommended maximum temperature.

Luminous Flux Rank

LEDs are sorted to Luminous Flux –lm bins shown. Orders for The LED may be filled with any or all bins contained as below. All Luminous Flux-lm shown and specified are at IF =60mA.

WS-L5256-CW-K1-1 Luminous Flux Ran

Luminous Flux Rank	N1	N2	P1
Luminous Flux (lm)	16-18lm	18-20 lm	20-22lm

Forward Voltage Rank

Rank	g	h	i	j
Voltage	2.8-3.0 V	3.0-3.2 V	3.2-3.4 V	3.4-3.6 V

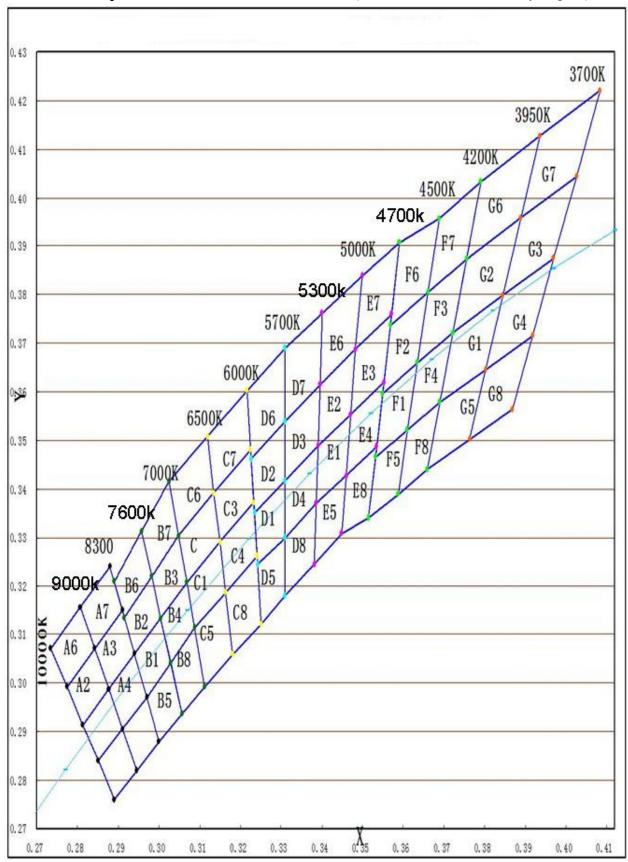
LEDs are sorted to VF bins shown. Orders for The LED may be filled with any or all bins contained as below. All VF values shown and specified are at IF =60mA.

Note: Measurement tolerance of the forward voltage: $\pm 0.06V$



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White Color Temperature Ranks & CIE Color Rank (Refer to CIE 1931 chromaticity diagram)





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CIE chromaticity coordinates

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C. A	C. A. S	X1	Y1	X2	Y2	ХЗ	Y 3	X4	¥4
	A1	0.2830	0.2840	0.2793	0.2914	0.2857	0.2987	0.2890	0.2905
	A2	0.2793	0.2914	0.2754	0.2993	0.2822	0.3071	0.2857	0.2987
	АЗ	0.2857	0.2987	0.2822	0.3071	0.2890	0.3150	0.2920	0.3060
1761	A4	0.2890	0.2905	0.2857	0.2987	0.2920	0.3060	0.2950	0.2970
A	A5	0.2870	0.2760	0.2830	0.2840	0.2890	0.2905	0.2925	0.2820
	A6	0.2754	0.2993	0.2714	0.3072	0.2787	0.3156	0.2822	0.3071
	A7	0.2822	0.3071	0.2787	0.3156	0.2860	0.3240	0.2890	0.3150
	A8	0.2925	0.2820	0.2890	0.2905	0.2950	0.2970	0.2980	0.2880
	B1	0.2950	0.2970	0.2920	0.3060	0.2984	0.3133	0.3009	0.3042
	B2	0.2920	0.3060	0.2895	0.3135	0.2962	0.3220	0.2984	0.3133
	В3	0.2984	0.3133	0.2962	0.3220	0.3028	0.3304	0.3048	0.3207
	В4	0.2984	0.3133	0.3048	0.3207	0.3068	0.3113	0.3009	0.3042
В	B5	0.2980	0.2880	0.2950	0.2970	0.3009	0.3042	0.3037	0.2937
	В6	0.2895	0.3135	0.2870	0.3210	0.2937	0.3312	0.2962	0.3220
	B7	0.2962	0.3220	0.2937	0.3312	0.3005	0.3415	0.3028	0.3304
	В8	0.3037	0.2937	0.3009	0.3042	0.3068	0.3113	0.3093	0.2993
	C1	0.3048	0.3207	0.3130	0.3290	0.3144	0.3186	0.3068	0.3113
	C2	0.3028	0.3304	0.3115	0.3391	0.3130	0.3290	0.3048	0.3207
	C3	0.3115	0.3391	0.3205	0.3481	0.3213	0.3373	0.3130	0.3290
	C4	0.3130	0.3290	0.3213	0.3373	0.3213	0.3261	0.3144	0.3186
C	C5	0.3068	0.3230	0.3213	0.3375	0.3221	0.3059	0.3093	0.2993
		· · · · · · · · · · · · · · · · · · ·			0.3509	0.3115	0.3391		0.3304
	C6	0.3005	0.3415	0.3099	The same second and the same second	The second second second		0.3028	
	C7	0.3099	0.3509	0.3196	0.3602	0.3205	0.3481	0.3115	0.3391
	C8	0.3144	0.3186	0.3221	0.3261	0.3231	0.3120	0.3161	0.3059
	D1	0.3215	0.3350	0.3290	0.3417	0.3290	0.3300	0.3222	0.3243
	D2	0.3207	0.3462	0.3290	0.3538	0.3290	0.3417	0.3215	0.3350
	D3	0.3290	0.3538	0.3376	0.3616	0.3371	0.3490	0.3290	0.3417
D	D4	0.3290	0.3417	0.3371	0.3490	0.3366	0.3369	0.3290	0.3300
	D5	0.3222	0.3243	0.3290	0.3300	0.3290	0.3180	0.3231	0.3120
	D6	0.3196	0.3602	0.3290	0.3690	0.3290	0.3538	0.3207	0.3462
	D7	0.3287	0.3690	0.3381	0.3762	0.3376	0.3616	0.3290	0.3538
	D8	0.3290	0.3300	0.3366	0.3369	0.3361	0.3245	0.3290	0.3180
	E1	0.3371	0.3490	0.3451	0.3554	0.3440	0.3427	0.3366	0.3369
	E2	0.3376	0.3616	0.3463	0.3687	0.3451	0.3554	0.3371	0.3490
	ЕЗ	0.3463	0.3687	0.3551	0.3760	0.3533	0.3620	0.3451	0.3554
E	E4	0.3451	0.3554	0.3533	0.3620	0.3515	0.3487	0.3440	0.342
ь	E5	0.3366	0.3369	0.3440	0.3428	0.3429	0.3307	0.3361	0.324
	E6	0.3381	0.3762	0.3480	0.3840	0.3463	0.3687	0.3376	0.361
	E7	0.3480	0.3840	0.3571	0.3907	0.3551	0.3760	0.3463	0.368
	E8	0.3440	0.3428	0.3515	0.3487	0.3495	0.3339	0.3429	0.330
	F1	0.3530	0.3597	0.3615	0.3659	0.3590	0.3521	0.3512	0.346
	F2	0.3548	0.3736	0.3641	0.3804	0.3615	0.3659	0.3530	0.359
	FЗ	0.3641	0.3804	0.3736	0.3874	0.3702	0.3722	0.3615	0.3659
22	F4	0.3615	0.3659	0.3702	0.3722	0.3670	0.3578	0.3590	0.352
F	F5	0.3512	0.3465	0.3590	0.3521	0.3567	0.3389	0.3495	0.3339
	F6	0.3571	0.3907	0.3668	0.3957	0.3641	0.3804	0.3548	0.3736
	F7	0.3668	0.3957	0.3771	0.4034	0.3736	0.3874	0.3641	0.3804
	F8	0.3590	0.3521	0.3670	0.3578	0.3640	0.3440	0.3567	0.3389
	G1	0.3670	0.3578	0.3702	0.3722	0.3825	0.3798	0.3783	0.3646
	G2	0.3702	0.3722	0.3736	0.3874	0.3869	0.3958	0.3825	0.379
	G3	0.3825	0.3798	0.3869	0.3958	0.4006	0.4044	0.3950	0.387
	G4	0.3783	0.3646	0.3825	0.3798	0.3950	0.3875	0.3898	0.371
G	G5	0.3670	0.3578	0.3783	0.3646	0.3743	0.3502	0.3640	0.344
	30	0.00,0	0.0070	~.~,~~	a particular construction of the	Transfer of the second second	7		T Recommendation
	70027027	0.3771	0.4034	0.3916	0.4127	0.3869	D 3958	0.3736	1387
	G6 G7	0.3771	0.4034	0.3916	0.4127	0.3869	0.3958	0.3736	0.3874

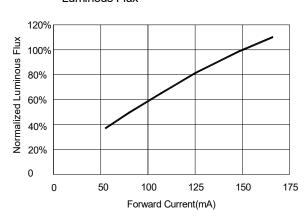
Color coordinates measurement allowance is ± 0.005



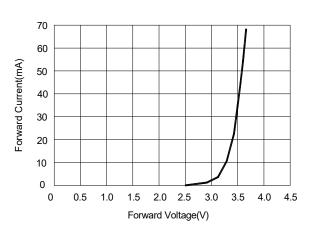
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Optical-Electrical Characteristic Graphs

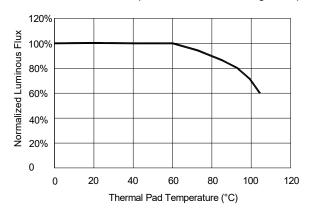
Forward Current vs. Typical Relative Luminous Flux



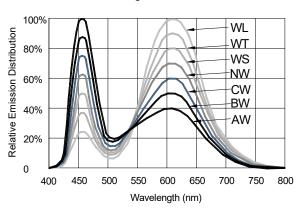
Forward Voltage vs. Forward Current



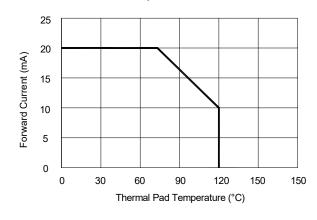
Thermal Pad Temperature vs. Relative Light Output



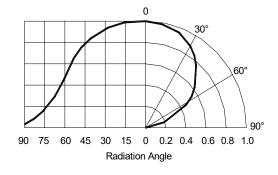
Wavelength Characteristics



Thermal Pad Temperature vs. Forward Current



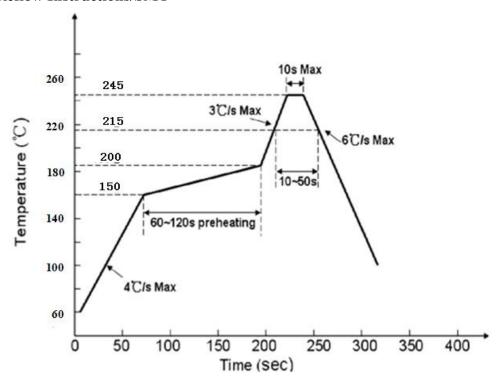
Typical Radiation Pattern 120°





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Lead-free Reflow Instructions/SMT



Curve Description	Lead-free Reflow Solder/SMT
The lowest preheat temperature (Tsmin)	150℃
The highest preheat temperature (Tsmax)	200℃
Preheating time (Tsmin to Tsmax) (ts)	60-180 S
Average rate of temperature rise (Tsmax to Tp)	<3°C/S
LIQUID REGION temperature (TL)	217℃
LIQUID REGION Holding Time (tL)	60-150 S
Peak Temperature (Tp)	245 ℃
High Temperature Region(Tp=-5℃) Holding Time (tp)	<10 S
Cooling Rate	<6°C/S
Room Temperature to Peak Holding Time	<6 min

♦ Remarks

- 1. This has to be baked for 48 hours at the baking temperature of 70-75°C before being used.
- 2. Use up with 2 hours after taking out from oven.
- 3. Please replace the unused LEDs into oven.



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♦ Reflow instruction

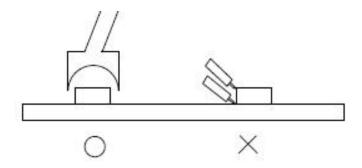
- 1. No more than two times of reflow.
- 2. Do not beat the colloid surface when the material is heated.

♦ Manual Soldering instruction

- 1. Soldering iron's temperature must be under 300°C, and operating time must be less than 3 seconds.
- 2. It should be done only once for the manual soldering.

♦ Repairing instruction

Normally, it can't be repaired after reflow. You need to use double-ended solder iron and make sure that whether it will do damage to the LEDs' characteristics when repairing is inevitable.



Storing and Transporting

1. Scope of application

Front side up, moisture-proof and waterproof, no extrusion, no collision and no vibration.

- 2. Storage and its period
- 1 Room temperature sealed storage: $20^{\circ}\text{C} \sim 30^{\circ}\text{C}$, $40\% \sim 60\%$ RH, product is valid for ONE week.
- 2 Moisture-proof sealed storage: 20°C ~ 30°C, 25% ~ 60%RH, product is valid for TWO weeks.
- \odot Use up with 2 hours after removing from packages.(Environmental conditions for temperature $<30^{\circ}$ C, relative humidity<60%)

♦ Dehumidification

We would recommend to do dehumidification if they exceed the valid storage period of products or dampened due to other reasons.

Dehumidification Method: $70^{\circ}\text{C}-75^{\circ}\text{C}/48\pm2$ Hours

♦ Electrostatic Protection

LED is an electrostatic sensitive component, although the LED products are with excellent anti-static ability, they will cause a certain damage by any electrostatic discharge. By taking some electrostatic measures to avoid the damages when using the LEDs, such as wearing anti-static gloves and anti-static bracelet, etc..



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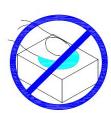
Precautions

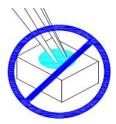
Pressing the colloid surface will affect the reliability of LED because the LED is advanced silicone-gel. And therefore precautions should be taken to avoid the strong pressure on the component. It's proper to make the LED be used in safe condition when using a suction nozzle. Silicon packing with soft and elastic, it greatly reduces thermal stresses and unable to bear external mechanical forces. Therefore, preventive measures should be taken in process of manually handling.

① Clip the LED from its side.

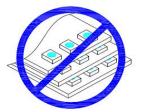


2 Neither directly touch the gel surface with the hand or sharp instrument, it may damage its internal circuit.





(3) Not to be double stacked, it may damage its internal circuit.



4 Can not be stored in or applied in the acidic sites of PH<7.





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Modify Records

Version №	Status Bar	Modify Content Summary	Date	Reviser	Approved
V1.0	N	New	20171129	Shen JinGuo	Yin HuaPing

Remarks: Initial version: V1.0; Version number plus "0.1" after each revision;

Status bar: N--New, A--Add, M--Modify, D--Delete.